LCD MODULE

SPECIFICATION

Model:	UE035DV-RB24-A050A
Version:	V1.0
Date:	20200721

☑ **Preliminary Specification** 样品规格书

☐ **Final Specification** 量产规格书

Customer Confirmation 客户确认

Approved by	Notes

Please return one of the copies of the specification with your signature to us within two weeks after you receive this document. If it is not returned, we will assume that you agree to the entire contents of this specification document.

请贵司在收到规格书的两周内，将签好字的规格书原件或者复印件寄回.如果没有返回，我司将会认为贵司已经默认接受产品规格书中的全部资料和规范.

VIEWE Confirmation 优奕确认

Prepared by	Reviewed by	Approved by

SHENZHEN VIEWE TECHNOLOGY CO., LTD

REVISION HISTORY

Revision 版本号	Date 日期	Contents of Revision Change 修改内容	Remark 备注
V1.0	2020.07.21	Preliminary release	

SHENZHEN VIEWE TECHNOLOGY CO., LTD

TABLE of CONTENTS

1. GENERAL INFORMATION....4
1.1 Features....4
1.2 Mechanical Specification....4
2. ABSOLUTE MAXIMUM RATINGS....5
3. MECHANICAL DRAWING....6
4. I/O CONNECTION & BLOCK DIAGRAM....7
4.1 I/O Connection....7
4.2 Block Diagram....8
5. ELECTRICAL CHARACTERISTICS....9
5.1 TFT-LCD Panel Driving Section....9
5.2 Back Light Driving Section....9
5.3 Power On/Off Sequence....10
5.4 Timing Characteristics....19
5.5 Timing Diagram....19-12
6. OPTICAL CHARACTERISTICS....23
7. RELIABILITY....26
8. PACKAGE DRAWING....27

SHENZHEN VIEWE TECHNOLOGY CO., LTD

1. GENERAL INFORMATION

1.1 Features

1) Pixel Arrangement：RGB_Stripe
2) Interface Mode： MIPI
3) Driver IC：ST7703-G5-DP Touch IC：GT1151Q
4) Operation Temperature：-30~70℃
5) Storage Temperature：-40~80℃
6) Backlight Type：White LED
7) Display mode：Normally Black,
8) Pixel Density：329 PPI
9) LED life time：30,000 Hours

1.2 Mechanical Specification

Item 项目	Specification 规格	Unit 单位	Remark 备注
Pixel Driving element	IPS TFT	-	
Screen Size	3.5	Inch	Diagonal
Resolution	640(W)*3(RGB)*960(H)	Dots	-
Interface	MIPI	-	2lanes
Module Power Consumption	0.6252	Watt	Typ.
Active Area	49.92(W)*74.88(H)	mm	-
VActive VArea	50.42(W)*75.38(H)	mm	-
Pixel pitch (W*H)	0.026(W)*0.078(H)	mm	-
CTP Module Size (W*H*D)	60.54(W)*92.91(H)*3.13(D)	mm	-
Luminance	300	cd/m^2	Typ.
Viewing Direction	All	O'clock	-
Display Color	16.7M	Colors	24bits

SHENZHEN VIEWE TECHNOLOGY CO., LTD

2. ABSOLUTE MAXIMUM RATINGS

Item 项目	Symbol 符号	Min. 最小值	Max. 最大值	Unit 单位	Remark 备注
Power supply1 voltage	VCC(2.8V)	-0.3	4.6	V	Note1
Power supply2 voltage	IOVCC(1.8V)	-0.3	4.6	V	
Power supply3 voltage	VDD(2.8V)	-0.3	4.2	V	
LED forward current	I_F	-0.001	20	mA	For each led,Note1
LED Reverse Voltage	V_R	-	5	V	For each led,Note1
Operating temperature	T_{op}	-20	70	℃	Note1,2
Storage temperature	T_{st}	-30	80	℃	Note1,2
Humidity	H_{st}	10	90	%RH	Note1,3

(Ta=+25°C,GND=0V)

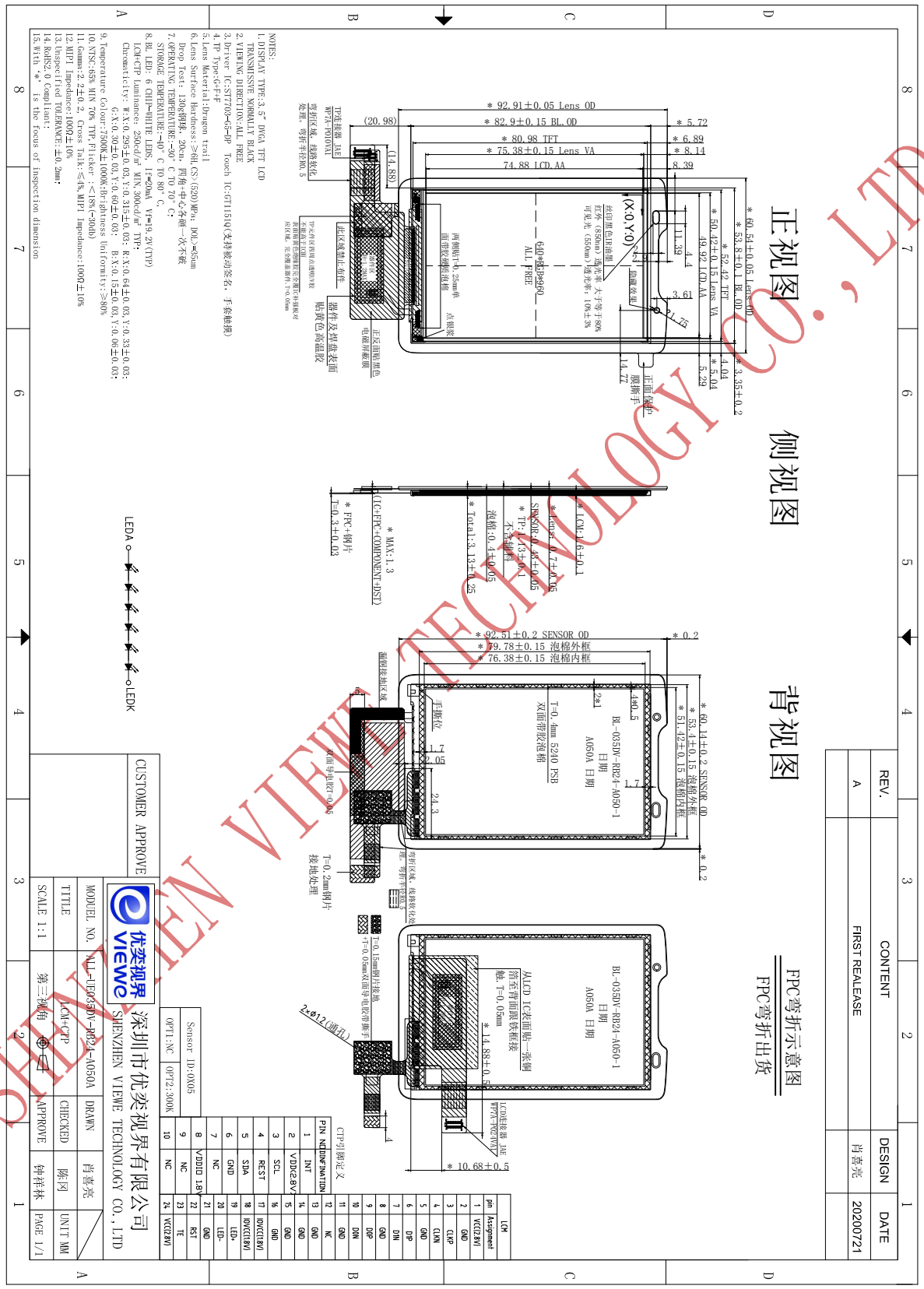
Note1:If the module exceeds the absolute maximum ratings, it may be damaged permanently. Also if the module operates with the absolute maximum ratings for a long time, the reliability may drop.

Note2: In case of temperature below 0℃,the response time of liquid crystal (LC) becomes slower and the color of panel darker than normal one.

Note3: Temp. ≤ 60℃ , 90% RH MAX.
Temp. ＞60℃ , Absolute humidity shall be less than 90% RH .

SHENZHEN VIEWE TECHNOLOGY CO., LTD

3. MECHANICAL DRAWING



SHENZHEN VIEWE TECHNOLOGY CO.,LTD

4. I/O CONNECTION & BLOCK DIAGRAM

4.1 I/O Connection

Pin No. 序号	Symbol 符号	I/O	Description 描述
1	VCC(2.8V)	P	Power supply for analog circuits(2.8V)
2	GND	P	Power Ground
3	CLKP	I	MIPI-DSI clock lane positive-end input pin
4	CLKN	I	MIPI-DSI clock lane negative-end input pin
5	GND	P	Power Ground
6	D1P	I	MIPI-DSI data lane 1 positive-end input pin
7	D1N	I	MIPI-DSI data lane 1 negative-end input pin
8	GND	P	Power Ground
9	D0P	I/O	MIPI-DSI data lane 0 positive-end input pin
10	D0N	I/O	MIPI-DSI data lane 0 negative-end input pin
11	GND	P	Power Ground
12	NC	-	No connected
13-16	GND	P	Power Ground
17-18	IOVCC(1.8V)	P	Power supply for logic circuits and IO pads(1.8V)
19	LED+	P	Power supply for backlight anode
20	LED-	P	Power supply for backlight cathode
21	GND	P	Power Ground
22	RST	I	The signal will reset the LCM, Signal is active low.
23	TE	O	Tearing effect outputsignal. If not used, please let this pin open
24	VCC(2.8V)	P	Power supply for analog circuits(2.8V)

I：Input；O：Output；P：Power

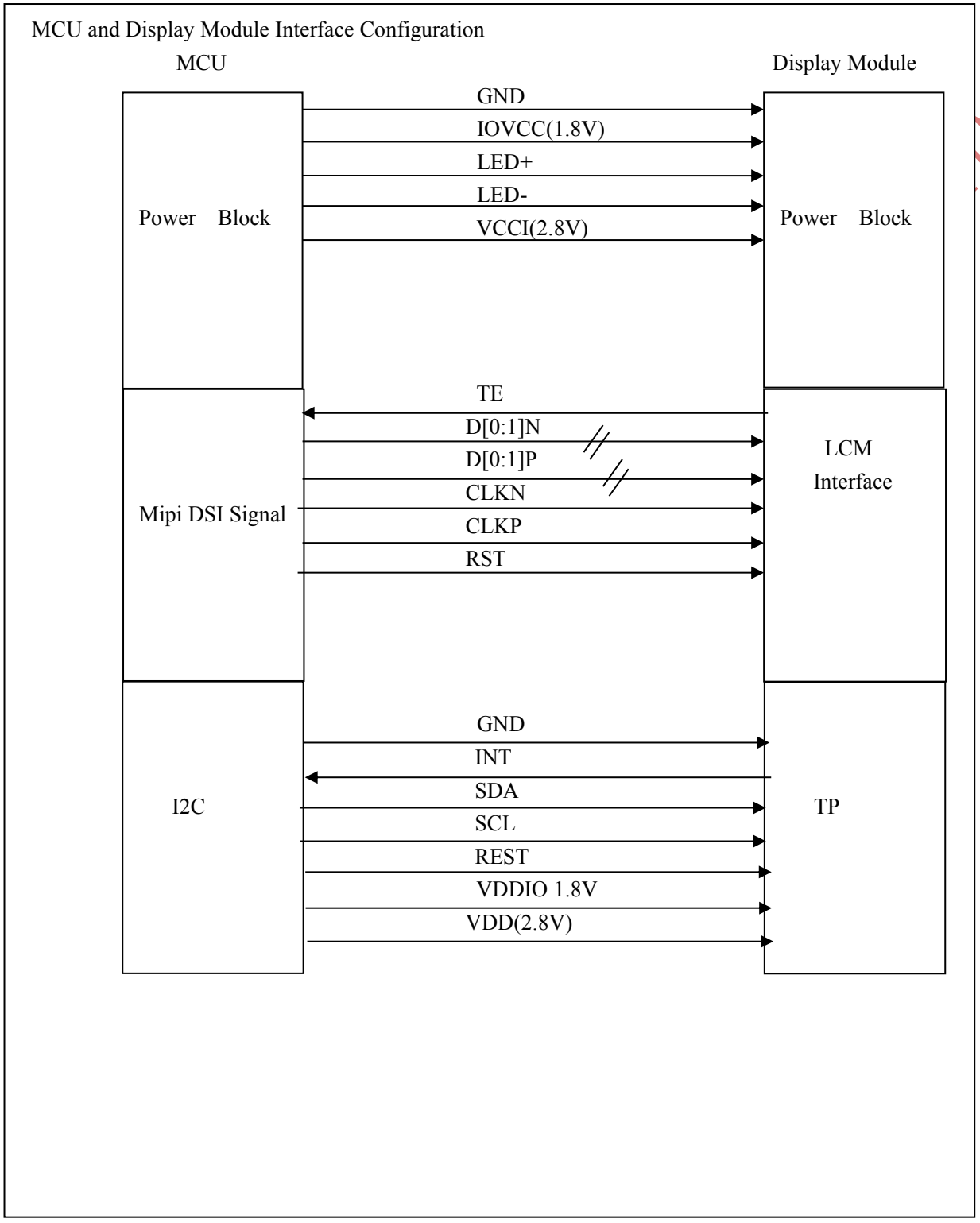
TP

Pin No. 序号	Symbol 符号	I/O	Description 描述
1	INT	O	Interrupt signals for TP
2	VDD(2.8V)	P	Power supply for analog circuits(2.8V)
3	SCL	I	I2C clock signals for TP
4	REST	I	The signal will reset the TP,Signal is active low
5	SDA	I/O	I2C data signal for TP
6	GND	P	Power Ground
7	NC	-	No connected
8	VDDIO 1.8V	P	Power supply for logic circuits and IO pads(1.8V)
9	NC	-	No connected
10	NC	-	No connected

VIEWE TECHNOLOGY

I：Input；O：Output；P：Power

4.2 Block Diagram



5. ELECTRICAL CHARACTERISTICS

5.1 TFT-LCD Panel Driving Section

Item 项目	Symbol符号	Min. 最小值	Typ. 典型值	Max. 最大值	Unit 单位	Remark 备注
Power Supply1 Voltage	IOVCC(1.8V)	1.65	1.8	2	V	-
Power Supply2 Voltage	VCC(2.8V)	2.5	2.8	3.6	V	
Power Supply3 Voltage	VDD(2.8V)	2.7	2.8/3.0/3.3	3.4	V	
Power Supply Current	$I_{VCC(2.8V)}$	-	27	-	mA	Note1
Power Supply Current	$I_{IOVCC(1.8V)}$	-	11	-	mA	
Power Supply Current	$I_{VDD(2.8V)}$		44		mA	
LCM Logic High level input voltage	V_{IH}	0.7IOVCC	-	IOVCC	V	-
LCM Logic Low level input voltage	V_{IL}	VSSA	-	0.3IOVCC	V	-
LCM Logic High level output voltage	V_{OH}	0.8IOVCC	-	0.8IOVCC		I_{OH}=-1.0mA
LCM Logic Low level output voltage	V_{OL}	VSSA		0.2IOVCC		I_{OL}=+1.0mA
Panel Power Consumption	P_{LCM}	-	0.48	-	Watt	Note1
Module Power Consumption	P_{ALL}	-	0.6252	-	Watt	Note1,2

(Ta=+25°C,GND=0V)

Note1:Measurement Conditions (Video Mode): Full Screen Red Pattern,VDD=2.8V,60Hz Refresh.

Note2: P_{ALL}= P_{LCM}+ P_{TP}， About P_{BL} information, inference to 5.2 Back Light Driving Section.

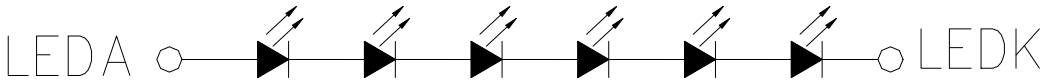
5.2 Back Light Driving Section

Item 项目	Symbol 符号	Min. 最小值	Typ. 典型值	Max. 最大值	Unit 单位	Remark 备注
Forward Voltage	V_F	-	19.2	-	V	Note1
Forward Current	I_F	-	20	-	mA	Note1
Backlight Power consumption	P_{BL}	-	0.384	-	Watt	Note1
LED life time	-	30000	-	-	Hours	Note2
LED Quantity			6		PCS	

(Ta=+25°C,GND=0V)

Note1: The LED driving condition is defined for each LED module (6 LED Serial, 1 LED Parallel)。
For each LED ： I_F=20mA,V_F=3.2V(Typ.),Ta=25℃。

Note2:The “LED life time” is defined as the module brightness decrease to 50% of original brightness at I_{LED}=20mA(Per Led). The LED life time could be decreased if operating I_{LED} is larger than 20mA.



SHENZHEN VIEWE TECHNOLOGY CO.,LTD

5.3 Power On/Off Sequence

5.3.1 Power on timing

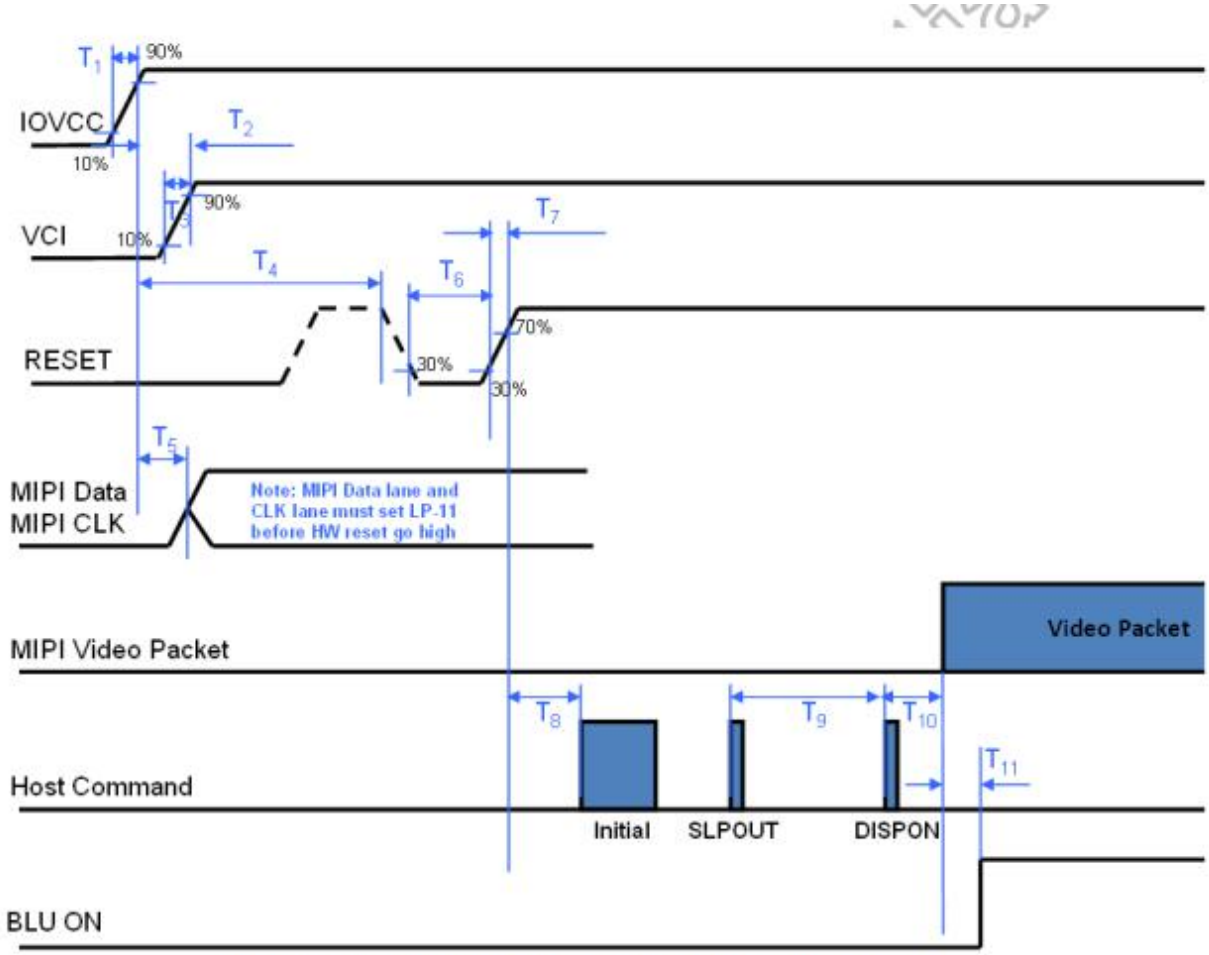


Figure 8-6: DSI Power On Sequence of Power IC Mode

	Min.	Typ.	Max.	Unit
T1	0.01	-	10	ms
T2		No Limit		ms
T3	0.01	-	10	ms
T4	1	-	-	ms
T5	1	-	-	ms
T6	10	-	-	us
T7		No Limit		ns
T8	15	-	-	ms
T9	120	-	-	ms
T10		No Limit		ms
T11	100	150	-	ms

Table 8-1: DSI Power On Timing of Power IC Mode

5.3.2 Power off timing

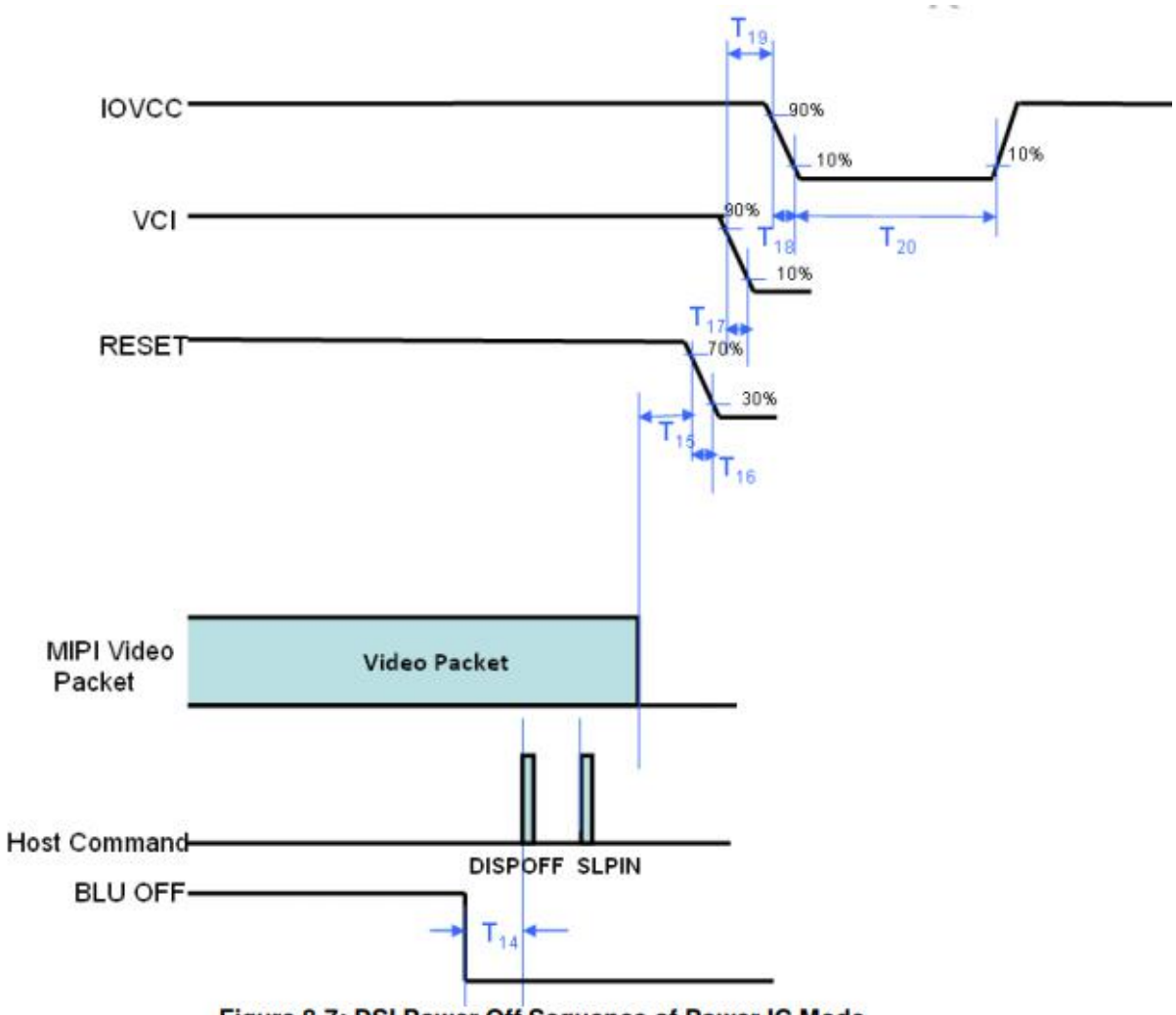


Figure 8-7: DSI Power Off Sequence of Power IC Mode

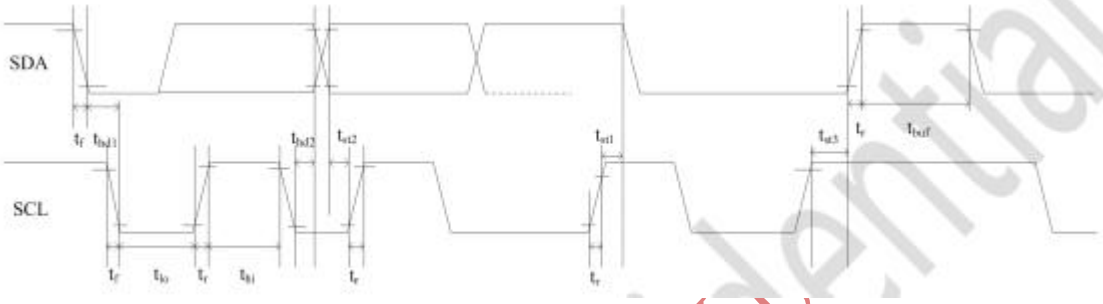
	Min.	Typ.	Max.	Unit
T14	40	100	-	ms
T15	10	-	-	ms
T16	No Limit			ms
T17	No Limit			ms
T18	No Limit			ms
T19	No Limit			ms
T20	100			ms

Table 8-2: DSI Power Off Timing of Power IC Mode

5.4 Timing Characteristics

5.4.0 I2C interface timings

GT1151Q 提供标准的 I²C 通讯接口，由 SCL 和 SDA 与主 CPU 进行通讯。 在系统中 GT1151Q 始终作为从设备，地址为 0X28/0X29。所有通讯都是由主 CPU 发起，建议通讯速度为 400Kbps 或以下。其支持的 I²C 硬件电路支持时序如下：



测试条件 2：3.3V 通讯接口，400Kbps 通讯速度，上拉电阻 2K

Parameter	Symbol	Min.	Max.	Unit
SCL low period	t_{lo}	1.3	-	us
SCL high period	t_{hi}	0.6	-	us
SCL setup time for START condition	t_{st1}	0.6	-	us
SCL setup time for STOP condition	t_{st3}	0.6	-	us
SCL hold time for START condition	t_{hd1}	0.6	-	us
SDA setup time	t_{st2}	0.1	-	us
SDA hold time	t_{hd2}	0	-	us

SHENZHEN

5.4.1 DC Characteristics

LP Mode

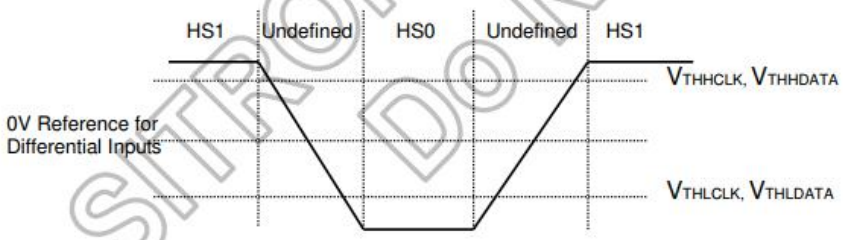
Parameter	Symbol	Conditions	Spec.			Unit
			Min.	Typ.	Max.	
Logic high level input voltage	V_{IHLPCD}	LP-CD	450	-	1350	mV
Logic low level input voltage	V_{ILLPCD}	LP-CD	0	-	200	mV
Logic high level input voltage	V_{IHLPRX}	LP-RX(CLK, D0)	880	-	1350	mV
Logic low level input voltage	V_{ILLPRX}	LP-RX(CLK, D0)	0	-	550	mV
Logic low level input voltage	$V_{ILLPRXULP}$	LP-RX(CLK ULP mode)	0	-	300	mV
Logic high level output voltage	V_{OHLPTX}	LP-TX(D0)	1.1	-	1.3	V
Logic low level output voltage	V_{OLLPTX}	LP-TX(D0)	-50	-	50	mV
Logic high level input current	V_{IH}	LP-CD, LP-RX	-	-	10	uA
Logic low level input current	V_{IL}	LP-CD, LP-RX	-10	-	-	uA
Input pulse rejection	SGD	DSI-CLK+/-, DSI-D0+/1	-	-	300	Vps

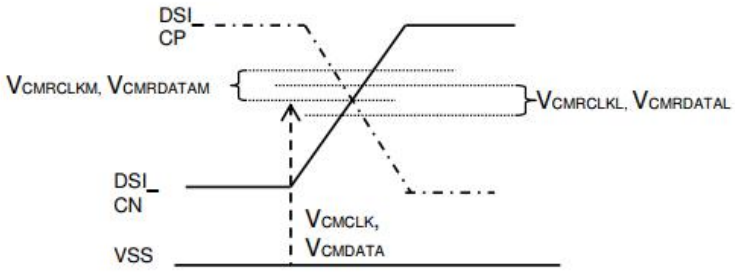
Figure 7.1: Input glitch rejections of low-power receivers

SHENZHEN VIEWE TECHNOLOGY Confidential Soft Copy

High Speed Mode

Parameter	Symbol	Conditions	Spec.			Unit
			Min.	Typ.	Max.	
Input common mode	V_{CMCLK} V_{CMDATA}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	70	-	330	mV
Input common mode variation <450 MHZ	$V_{CMRCLKL}$ $V_{CMRDATAL}$	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-50	-	50	mV
Input common mode variation >450 MHZ	$V_{CMRCLKM}$ $V_{CMRDATAM}$	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	100	mV
Low-level differential Input threshold	V_{THLCLK} $V_{THLDATA}$	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-70	-	-	mV
High-level differential Input threshold	V_{THHCLK} $V_{THHDATA}$	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	70	mV
Single ended input low voltage	V_{ILHS}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-40	-	-	mV
Single ended input high voltage	V_{IHHS}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	460	mV
Differential input termination resistor	R_{TERM}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	80	100	125	Ω
Single-ended threshold voltage for termination enable	V_{TERMEN}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	450	mV
Termination capacitor	C_{TERM}	DSI_CP/DSI_CN DSI_D0P/DSI_D0P	-	-	-	pF





SITRONIX Confidential
Do Not Copy
SHENZ

5.4.2 AC Characteristics

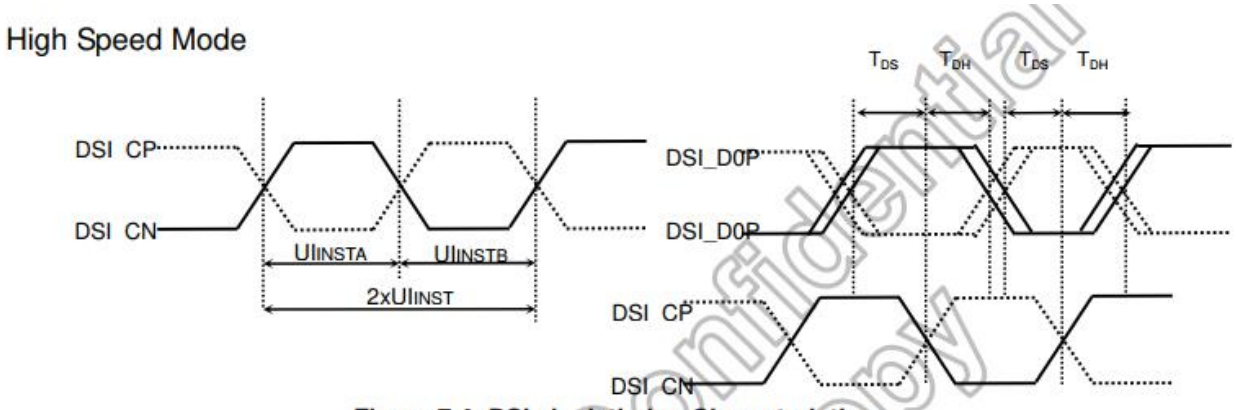


Figure 7.4: DSI clock timing Characteristics

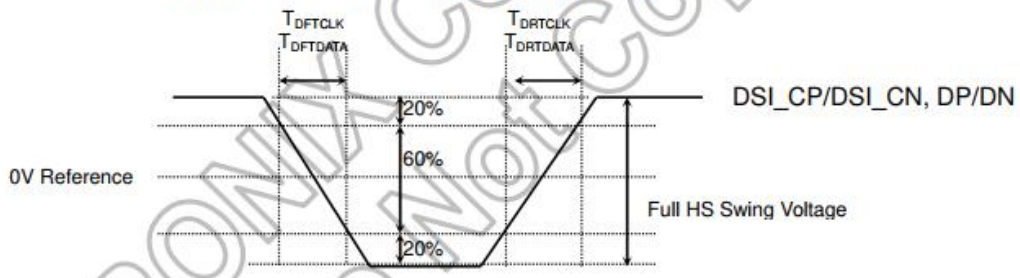


Figure 7.5: Rising and falling time on clock and data channel

(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.5V to 3.3V, T_A = -30 to 70°C)

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_CP/ DSI_CN	Double UI instantaneous	$2xU_{INST}$	TBD	-	25	ns
	UI instantaneous	U_{INSTA} U_{INSTB}	TBD	-	12.5	ns
DP/DN	Data to clock setup time	T_{DS}	0.15xUI	-	-	ps
	Data to clock hold time	T_{DH}	0.15xUI	-	-	ps
DSI_CP/ DSI_CN	Differential rise time for clock	T_{DRTCLK}	150	-	0.3UI	ps
	Differential fall time for clock	T_{DFTCLK}	150	-	0.3UI	ps
DP/DN	Differential rise time for data	$T_{DRTDATA}$	150	-	0.3UI	ps
	Differential fall time for data	$T_{DFTDATA}$	150	-	0.3UI	ps

Table 7.3: DSI High Speed Mode Characteristics

SITRONIX Confidential Do Not Copy

Low Power Mode

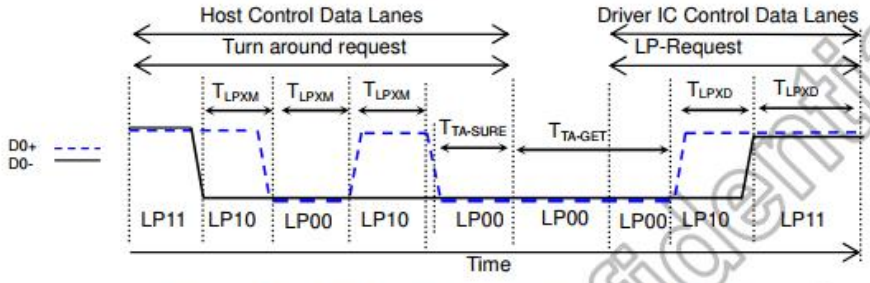


Figure 7.6: BTA from HOST to Display Module Timing

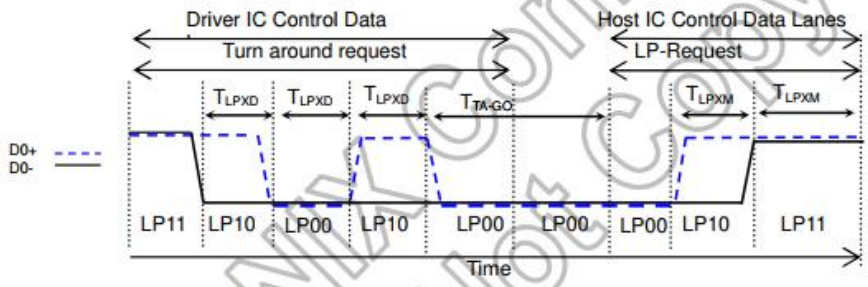


Figure 7.7: BTA from Display Module Timing to HOST

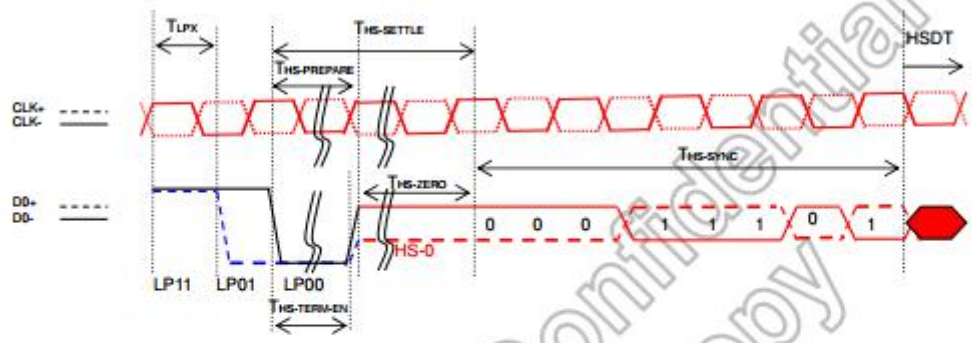
(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.3V to 3.3V, T_A = -30 to 70°C)

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Length of LP-00/LP01/LP10/LP11 Host→ Display module	T_{LPXM}	50	-	-	ns
	Length of LP-00/LP01/LP10/LP11 Display module →Host	T_{LPXD}	50	-	-	ns
	Time-out before the MPU start driver	$T_{TA-SURE}$	T_{LPXD}	-	2xT_{LPXD}	ns
	Time to drive LP-00 by display module	T_{TA-GET}	5xT_{LPXD}	-	-	ns
	Time to drive LP-00 after turnaround request Host	T_{TAGO}	4xT_{LPXD}	-	-	ns

Table 7.4: DSI Low Power Mode Characteristics

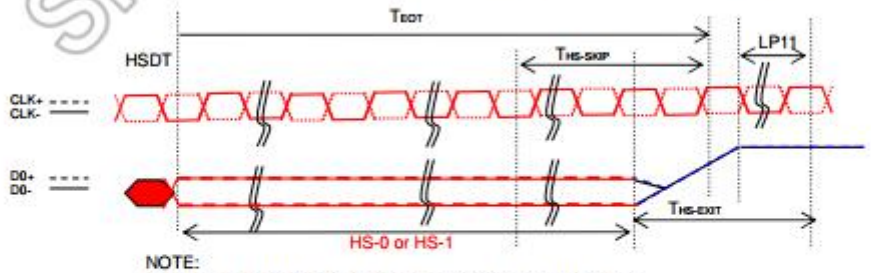
SHENZHEN VIEWE ELECTRONICS Confidential Do Not Copy

DSI BURSTS



Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Length of LP-00/LP01/LP10/LP11	T_{LPX}	50	-	-	ns
	Time to Driver LP-00 to prepare for HS transmission	$T_{HS-PREPARE}$	40+4UI	-	85+6UI	ns
	Time to enable data receiver line termination	$T_{HS-TERM-EN}$	-	-	35+4xUI	ns
	Time to drive LP-00 by display module	T_{TA-GET}	5xT_{LPXD}	-	-	ns
	Time to drive LP-00 after turnaround request Host	T_{TAGO}	4xT_{LPXD}	-	-	ns

Table 7.5: DSI Low Power Mode to High Speed Mode Timing

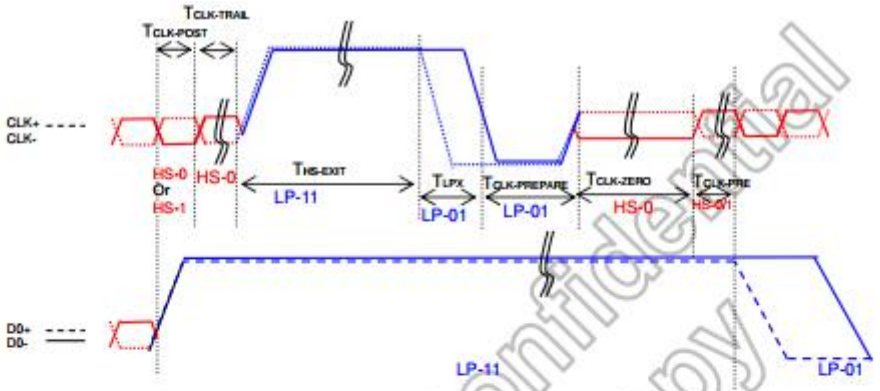


NOTE:
If the last bit is HS-0, the transmitter changes from HS-0 to HS-1
If the last bit is HS-0, the transmitter changes from HS-1 to HS-0

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Time-Out at Display Module to Ignore Transition Period of EoT	$T_{HS-SKIP}$	40	-	55+4xUI	ns
	Time to Driver LP-11 after HS Burst	$T_{HS-EXIT}$	100	-	-	ns

Table 7.6: DSI Low Power Mode to High Speed Mode Timing

SHEN
SITRONIX Confidential
Do Not Copy



Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_CP/ DSI_CN	Time that the MCU shall continue sending HS clock after the last associated Data Lane has transitioned to LP mode	$T_{CLK-POST}$	60+52xUI	-	-	ns
	Time to drive HS differential state after last payload clock bit of a HS transmission burst	$T_{CLK-TRAIL}$	60	-	-	ns
	Time to drive LP-11 after HS burst	$T_{HS-EXIT}$	100	-	-	ns
	Time to drive LP-00 to prepare for HS transmission	$T_{CLK-PREPARE}$	38	-	95	ns
	Time-out at Clock Lane Display Module to enable HS Termination	$T_{CLK-TERM-EN}$	-	-	38	ns
	Minimum lead HS-0 drive period before starting Clock	$T_{CLK-PREPARE}$ + $T_{CLK-ZERO}$	300	-	-	ns
	Time that the HS clock shall be driven prior to any associated data Lane beginning the transition from LP to HS mode	$T_{CLK-PRE}$	8xUI			

Table 7.7: Clock Lanes High Speed Mode to/from Low Power Mode Timing

SHENZHEN VIEWE Confidential Do not Copy LTD

5.5 Timing Diagram

Reset input timing

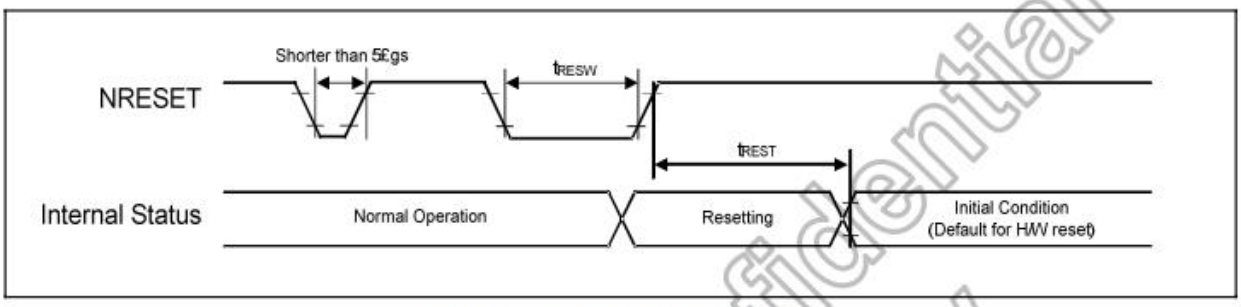


Figure 7.8: Reset input timing

Symbol	Parameter	Related Pins	Spec.			Note	Unit
			Min.	Typ.	Max.		
tRESW	Reset low pulse width(1)	NRESET	10	-	-	-	µs
tREST	Reset complete time(2)	-	15	-	-	When reset applied during SLPIN mode	ms
		-	120	-	-	When reset applied during SLPOUT mode	ms

Table 7.8: Reset Input Timing

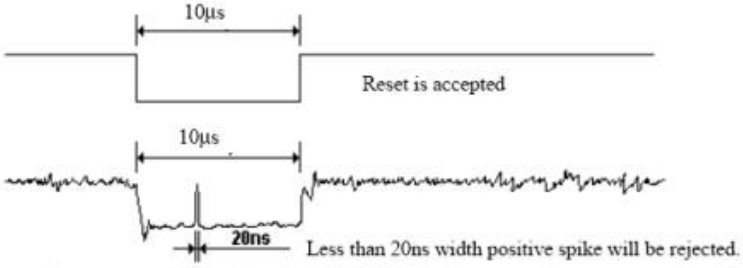
Note: (1) Spike due to an electrostatic discharge on NRESET line does not cause irregular system reset according to the following table.

NRESET Pulse	Action
Shorter than 5 µs	Reset Rejected
Longer than 10 µs	Reset
Between 5 µs and 10 µs	Reset Start

(2) During the resetting period, the display will be blanked (The display is entering blanking sequence, which Maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode) and then return to Default condition for H/W reset.

(3) During Reset Complete Time, ID and VCOM value in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 15ms after a rising edge of NRESET.

(4) Spike Rejection also applies during a valid reset pulse as shown as below:



(5) It is necessary to wait 15msec after releasing NRESET before sending commands. Also Sleep Out command cannot be sent for 120msec.

SITRONIX Confidential Do Not Copy

5.5.1 Horizontal Timings

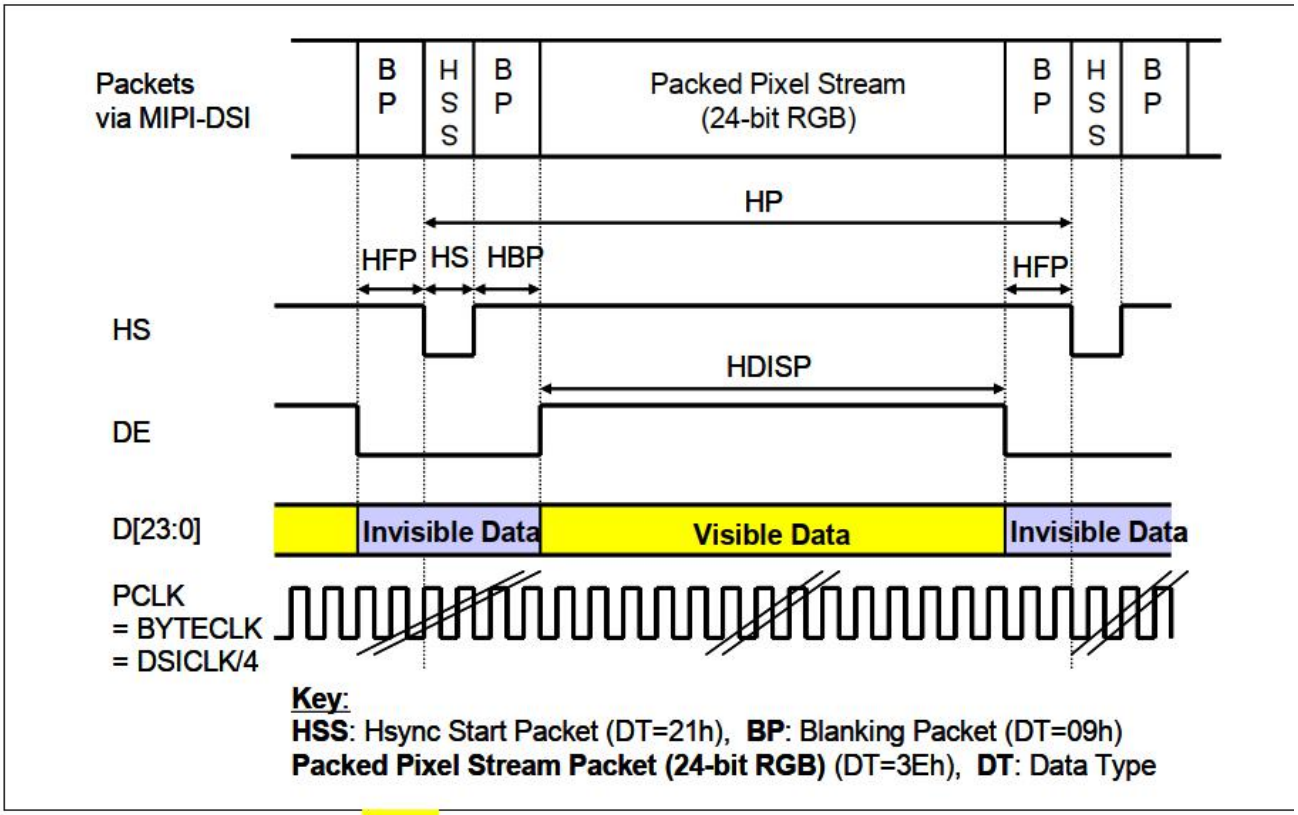


Figure 5 Horizontal Display Timing (MIPI-DSI)

Table 14 Horizontal Timing

Item	Symbol	Condition	Unit	Min.	Typ.	Max.	Notes
Horizontal front porch	HFP		PCLK	16	-	-	(2)
Horizontal data start point	-	HS+HBP	PCLK	16	-	-	(2)
Horizontal active area	HDISP		PCLK	480	640	640	(1), (2)

Notes: (1) Typical values are for 2xVGA (640 x 960) application.
(2) PCLK is pixel clock and same as BYTECLK that is generated by dividing DSICLK by 4.

SHENZ

5.5.2 Vertical Timings

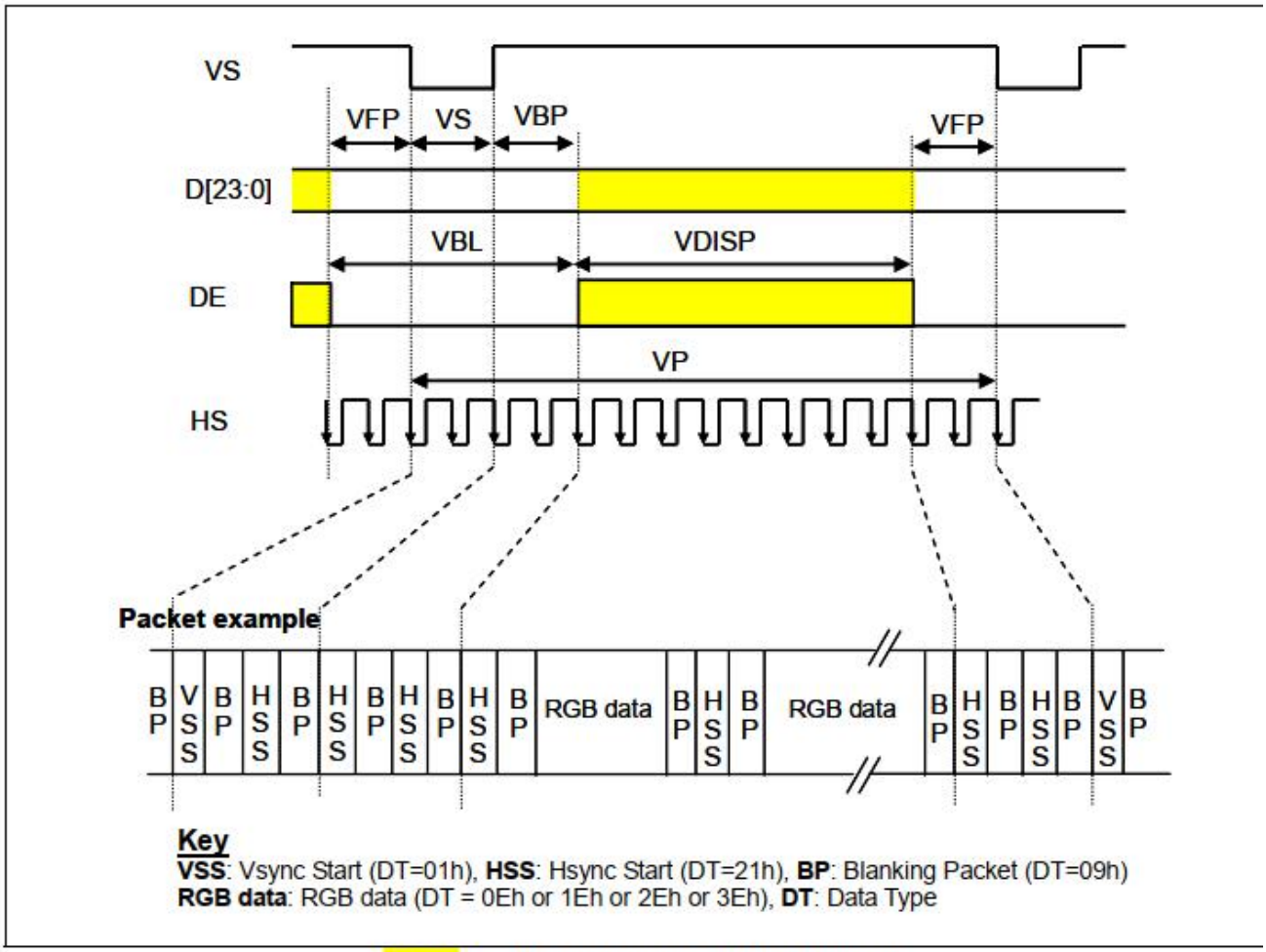


Figure 4 Vertical Display Timing (MIPI-DSI)

Table 13 Vertical Timing

Item	Symbol	Condition	Unit	Min.	Typ.	Max.	Notes
Vertical cycle	VP		line	-	1000		(1)
Vertical low pulse width	VS		line	-	16	-	(1), (2)
Vertical front porch	VFP		line	-	12		(1)
Vertical back porch	VBP		line	-	12		(1), (2)
Vertical data start point	-	VS+VBP	line	-	28	-	(1)
Vertical blanking period	VBL	VS+VBP+VFP	line	-	40	-	(1)
Vertical active area	VDISP		line	-	960	1080	(1)
(Vertical Refresh area)	(VRR)		Hz	-	60	-	(1)

Notes :(1) Typical values are for 2xVGA (640 x 960) application.
(2) VS +VBP is set as back porch by BP[3:0] bits @ C1h command.

5.5.3 Timing Parameters

Parameter	Symbol	Value			Unit
		Min.	Typ.	MAX.	
Bit rate per lane	BR_{PHY}	80	-	1000	Mbps
Active pixel per line	HACT	-	640	-	Pixels
Horizontal back porch	t_{HBP}	-	20	-	DCLK
Horizontal sync active	t_{HSA}	-	10	-	DCLK
Horizontal front porch	t_{HFP}	-	30	-	DCLK
Active pixel per frame	VACT	-	960	-	H
Vertical back porch	t_{VBP}	-	24	-	H
Vertical sync active	t_{VSA}	-	4	-	H
Vertical front porch	t_{VFP}	-	16	-	H

SHENZHEN VIEWE TECHNOLOGY CO.,LTD

6. OPTICAL CHARACTERISTICS

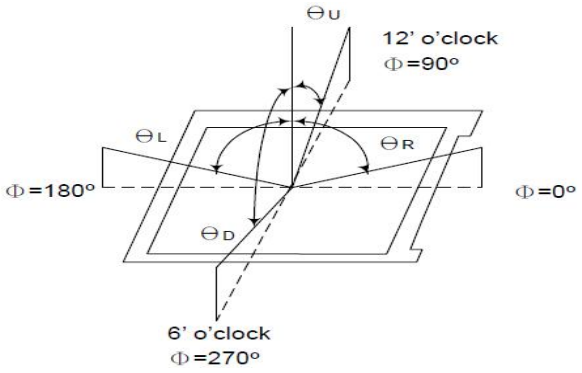
Parameter 参数	Symbol 符号	Condition 条件	Min. 最小值	Typ. 典型值	Max. 最大值	Unit 单位	Remark 备注
Contrast Ratio	C/R	θ = 0°	800	1000	-	-	Note(4)
NTSC Ratio	S	θ =0°	65	70	-	%	Note(7)
Luminance	L	θ =0°	-	300	-	cd/m2	Note(5)
Luminance uniformity	U_W	θ =0°	-	80	-	%	Note(3)
Response Time	T_R+ T_F	25 °C	-	25	30	ms	Note(2)
Color Coordination	W_X	θ = 0° (Center) Normal viewing angle B/L On	-0.03	0.295	+0.03	NTSC (x,y)	Note(6)
	W_Y			0.315			
	R_X			0.64			
	R_Y			0.33			
	G_X			0.30			
	G_y			0.60			
	B_X			0.15			
	B_Y			0.06			
Viewing Angle	Θ_1	C/R>10	75	85	-	Degree	Note(1)
	θ_R		75	85	-		
	θ_U		75	85	-		
	θ_D		75	85	-		

Test Conditions:

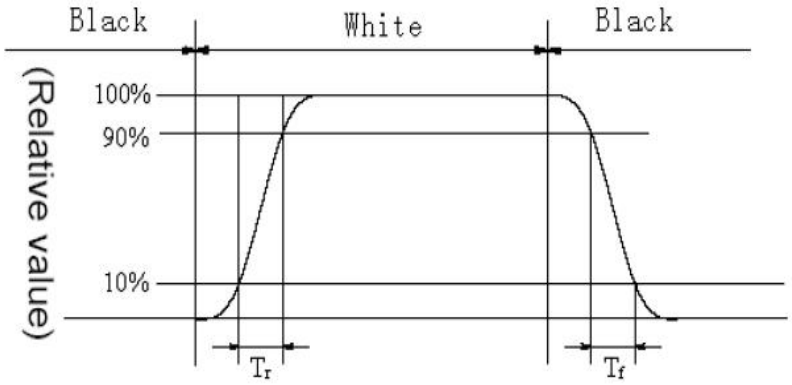
1. The ambient temperature is+25℃.
2. The test systems refer to Note 8.

SHENZHEN VIEWE TECHNOLOGY CO.,LTD

Note1: Definition of Viewing Angle: The viewing angle range that the CR>10

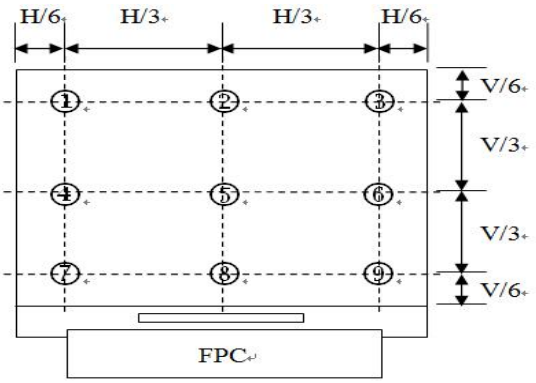


Note2: Definition of Response time: Sum of T_R and T_F



Note 3: Definition of Luminance Uniformity: Active area is divided into 9 measuring areas, every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity} = \frac{\text{Min Luminance of white among 9-points}}{\text{Max Luminance of white among 9-points}} \times 100\%$$



Note4: Definition of Contrast Ratio (CR): measured at the center point of panel

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

SHENZHEN VIEWE TECHNOLOGY CO., LTD

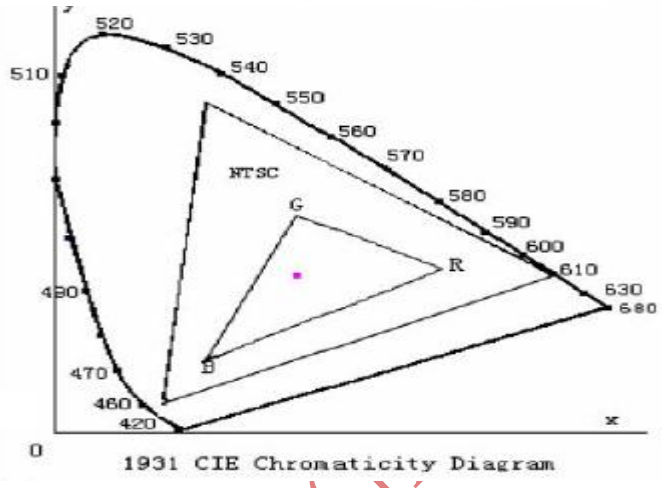
Note 5: Definition of Luminance: Center Luminance of white is defined as luminance values of 1point average across the LCD surface.

Note 6: Definition of Color Chromaticity (CIE 1931)

Color coordinates of white & red, green, blue measured at center point of LCD.

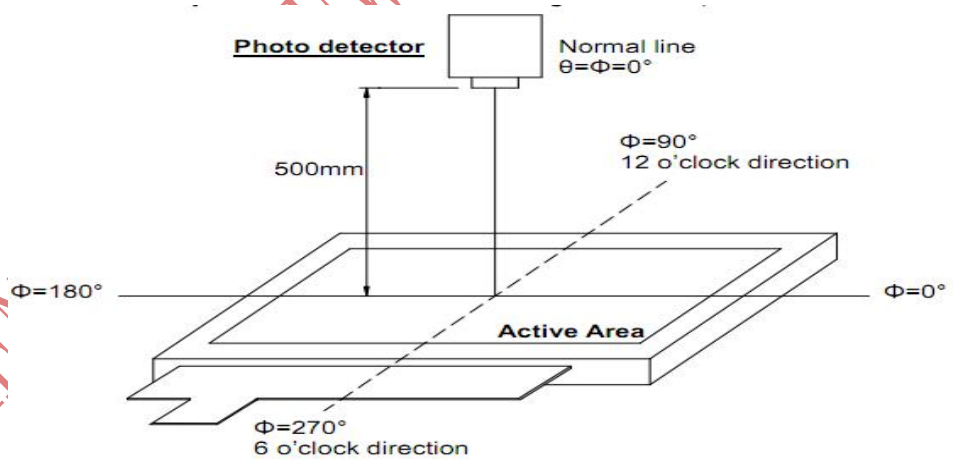
Note 7: Definition of NTSC ratio:

$$\text{NTSC ratio} = \frac{\text{Area of RGB triangle}}{\text{Area of NTSC triangle}}$$



Note 8: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen.(Response time is measured by Photo detector TOPCON BM-7, Field of view: 1°/Height: 500mm.)



7. RELIABILITY

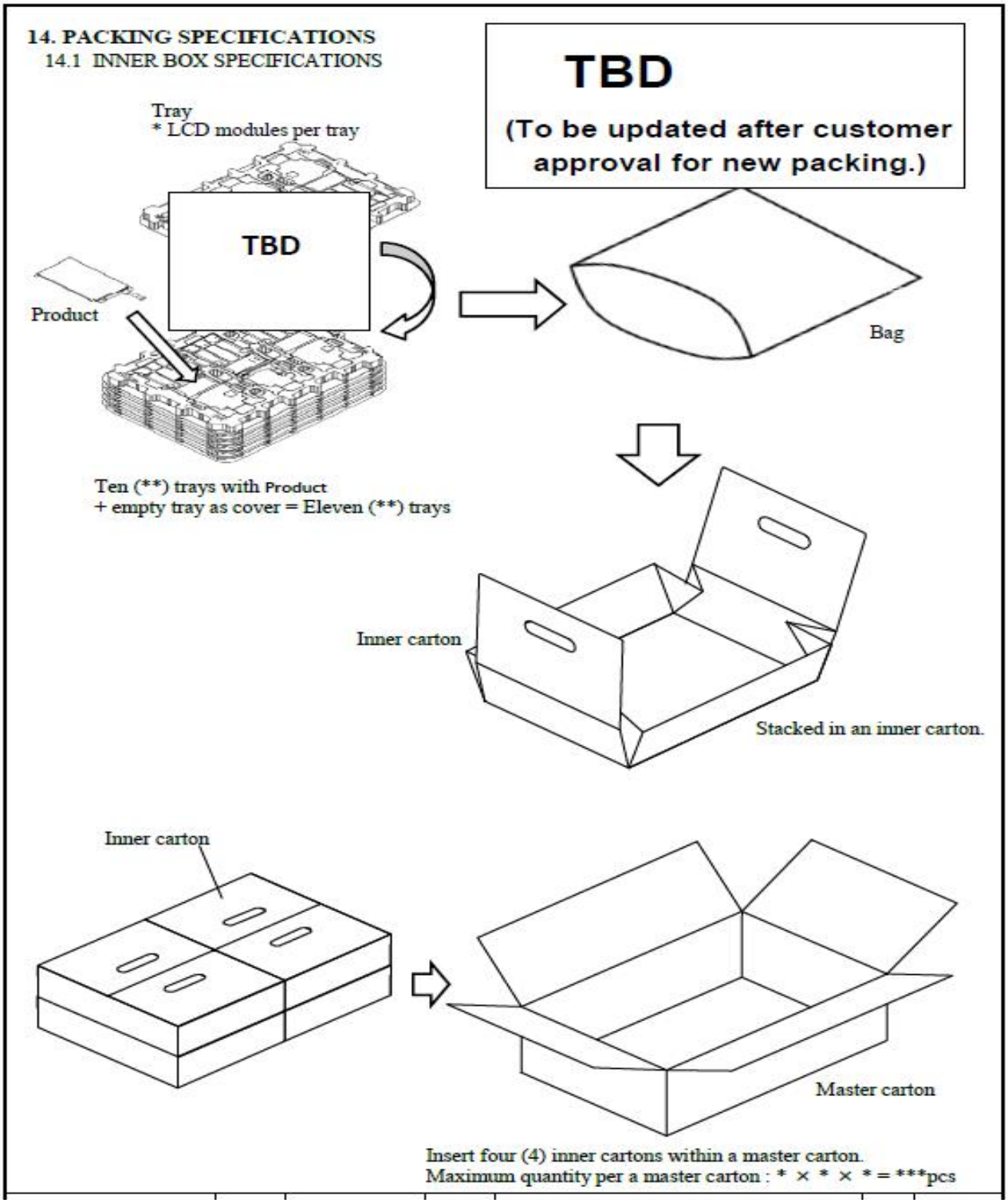
Item 项目	Test Condition 测试条件	Remark 备注
High Temperature Storage	Ta =+80°C / 96Hours	Note1,2,3
Low Temperature Storage	Ta =-40°C / 96Hours	Note1,2,3
High Temperature Operating	Ta =+70°C / 96Hours	Note1,2,3
Low Temperature Operating	Ta =-30°C / 96Hours	Note1,2,3
Temperature Cycle storage Test	-40°C/30min ⇆+80°C /30min for 30cycles,Transfer time less than 5min	Note2,3
Thermal humidity storage Test	70°C x 90%RH / 96Hours	Note2,3
Package Vibration Test	Frequency: 10Hz~55Hz,Amplitude:1.5mm, 1 hrs for each direction of X, Y, Z	Note2
Packing shock test	Drop to the ground from 60cm height, 1 corner, 3 edges, 6 surfaces.	Note2

Inspection after Test:

Note1:Ta is the ambient temperature of samples.

Note 2: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but doesn't guarantee all the cosmetic specification.

Note 3: Before cosmetic and function tests , the product must have enough recovery time, at least 2 hours at room temperature.

SHENZHEN VIEWE TECHNOLOGY CO., LTD

8. PACKAGE DRAWING